

**DESIGN AUTOMATION
EMBEDDED SYSTEMS**

FPGA - SECURITY - INTERNET OF THINGS - ELECTRONIC DESIGN & PRODUCTION -
EMBEDDED - DESIGN FOR EXCELLENCE - EMBEDDED DESIGN CHALLENGES

7 NOV ←
TECHNOPOLIS
BELGIË

8 NOV ←
VAN DER VALK HOTEL
EINDHOVEN

**D&E
event
2018**



USB 3.x – a connector for multiple applications



**more
than you
expect**

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- Why Type USB 3.1 & Type C
- History of USB and Evolution
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Why Type USB 3.1 & Type C

Market trends for USB (3.1)



➤ Storage / USB Sticks:

- Annual shipment of USB sticks could reach 556 kk units in 2020
- US Biggest market
- +8% growth is expected for Asia / Pacific area

➤ Power supply:

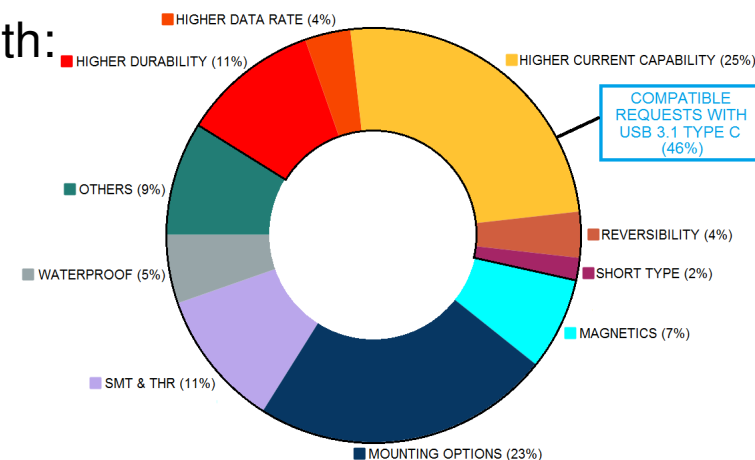
USB connectors are more and more often used as power suppliers:

- Customers are asking for high current connectors (1.8A / 2.1A & 3A)
- Smartphones, tablets, navigation systems are always requesting more & more power and need to be charged faster

➤ Survey on 90 WE customers in America:

USB 3.1 Type C fits with customers' expectations with:














- Higher durability
- Higher data rate
- Higher current capability (Power supply)
- Reversibility feature
- Short Type (for integrated applications)



Sources: <http://www.strategyr.com>

A little bit of history – ...to USB 3.1



Year/Version	USB 2.0 – 2000	USB 3.0 – 2008	USB 3.1 – 2013
➤ A			
➤ B			
➤ Mini			
➤ Micro			
➤ C			
➤ Data rate	480 Mbps	5000 Mbps	10000 Mbps
➤ Power	500mA / 5V	900mA / 5V	5A / 20V



Specification, Requirements & Performances

Electrical

- Contact resistance
 - V_{BUS} & GND Pins : 30mΩ max
 - Other Pins: 50mΩ max
 - $\Delta_{\text{CONTACT RESISTANCE}}$: 10mΩ max after mating cycles
- Insulation resistance > 100MΩ
- Dielectric Withstanding Voltage > 100MΩ
- Contact Current & Voltage rating:

Type	A		B		Micro B		C		
	Power Pins	Other Pins	Power Pins	Other Pins	Power Pins	Other Pins	Power Pins		Other Pins
Pin Number	1 & 4	-	1 & 4	-	1 & 5	-	A1,A4,A9 & A12 B1,B4,B9 & B12	A5 & B5	-
Current	1.8 A	0.25 A	1.8 A	0.25 A	1.8 A	0.25 A	1.5 / 5 A	1.25 A	0.25 A
Voltage	5 V								



Specification, Requirements & Performances

Mechanical

➤ Durability – Mating cycles

	A	B	Micro B	C
Mating cycles	1500 or 5000		10000	
Speed	200 cycles / hour			

➤ Insertion force

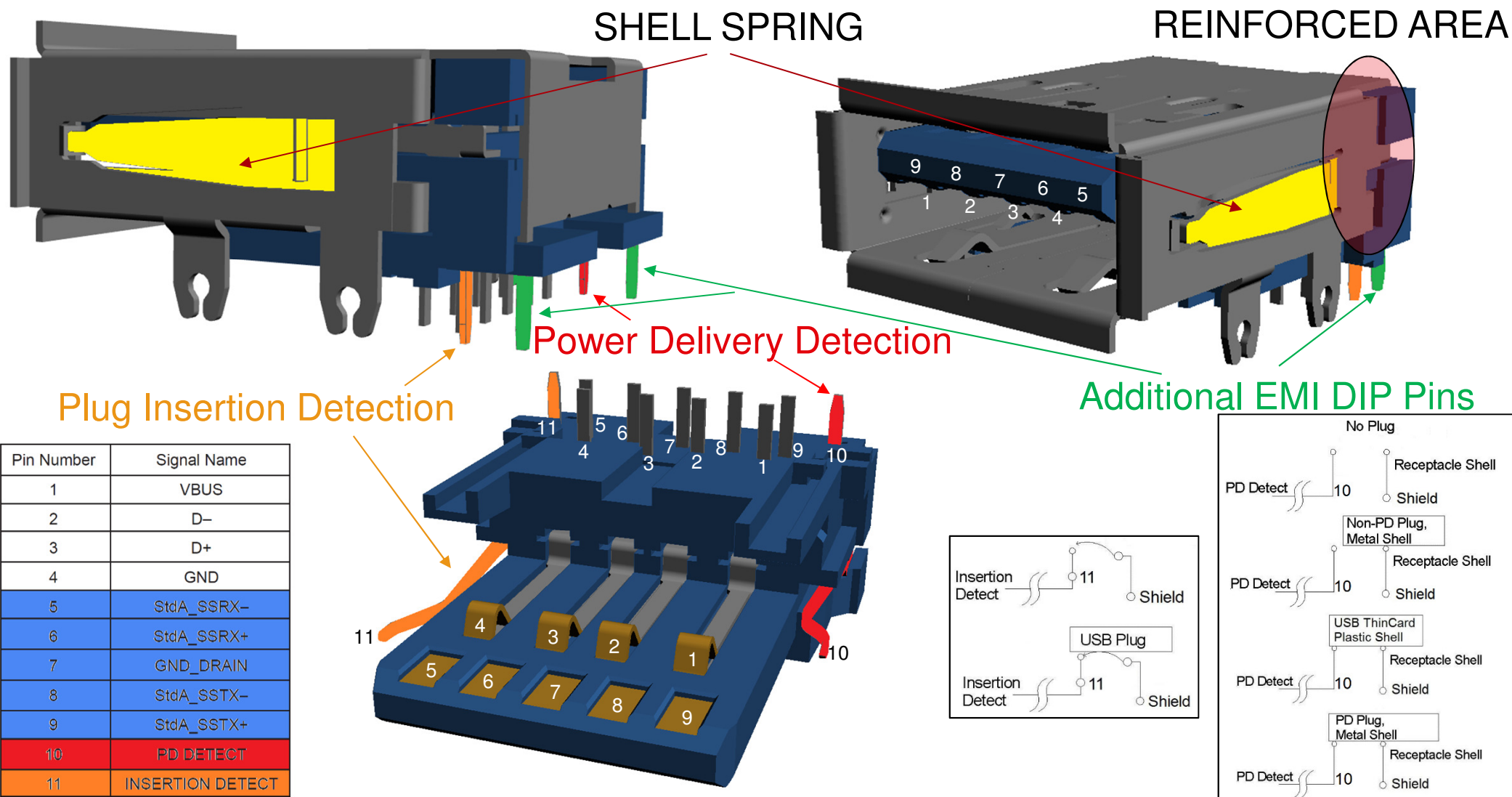
	A	B	Micro B	C
Insertion force	< 35 N	< 35 N	< 35 N	5 N to 8 N
Speed	12.5 mm / min			

➤ Extraction force (retention)

	A	B	Micro B	C
Standard mating cycles	1500	1500	10000	10000
Before mating cycles	> 10 N	> 10 N	10 N < Force < 25 N	8 N < Force < 20 N
After 1000 cycles	-	-	-	6 N < Force < 20 N
At max. cycles	> 8 N	> 8 N	8 N < Force < 25 N	6 N < Force < 20 N
Speed	12.5 mm / min			

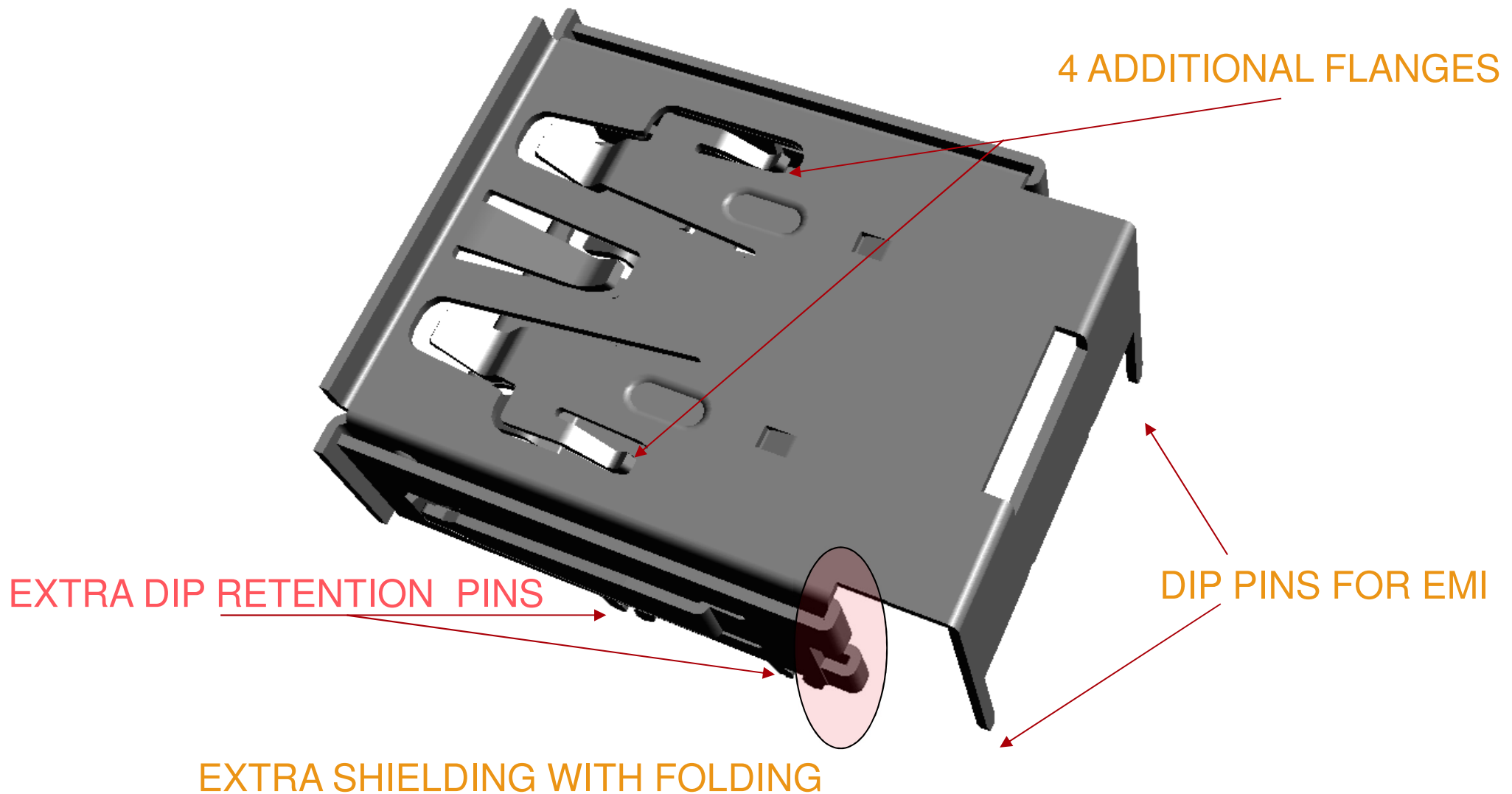
USB 3.1 Product Overview

PD Type A Receptacle – 632 121 300 001



USB 3.1 Product Overview

PD Type A Receptacle – 632 121 300 001

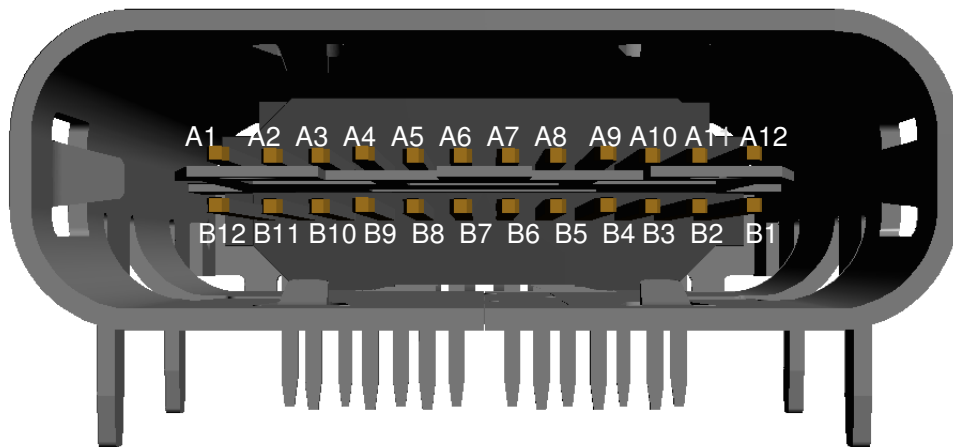




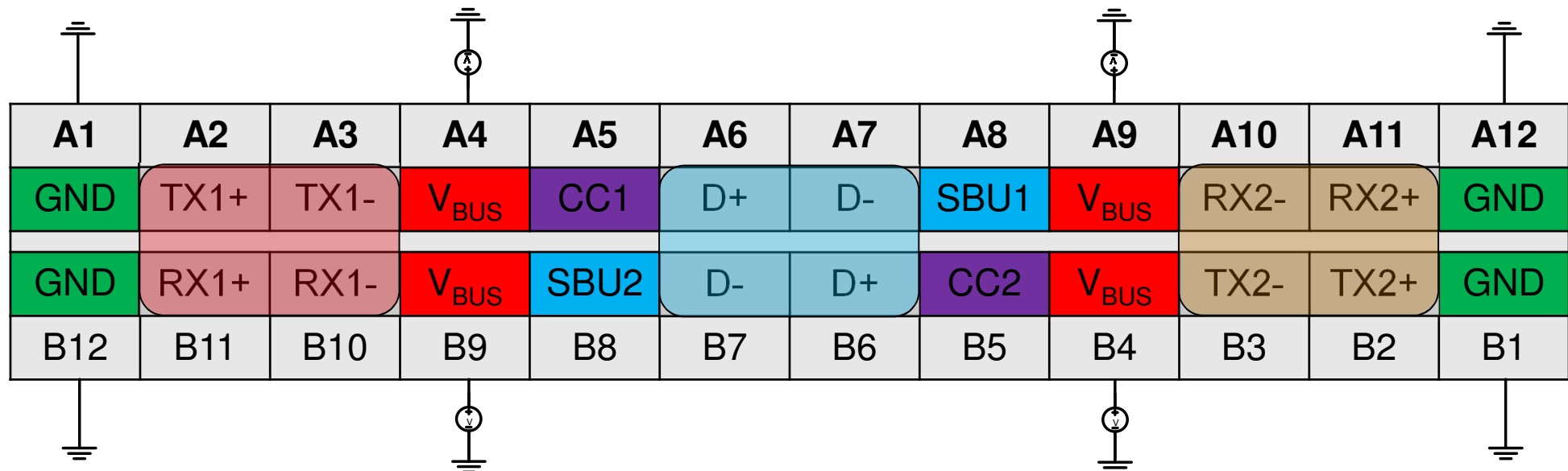
PD Type A Receptacle – Conclusion

- Supports Power Delivery with:
 - 5 A
 - 5V / 12V / 20 V
- Improved EMI/RFI Performances of at least 10 dB
 - 4 Additional flanges
 - Improved shielding
 - 2 Additional DIP pins for Ground
- Compatibility with USB 2.0 & USB 3.0
- 5 000 Mating cycles

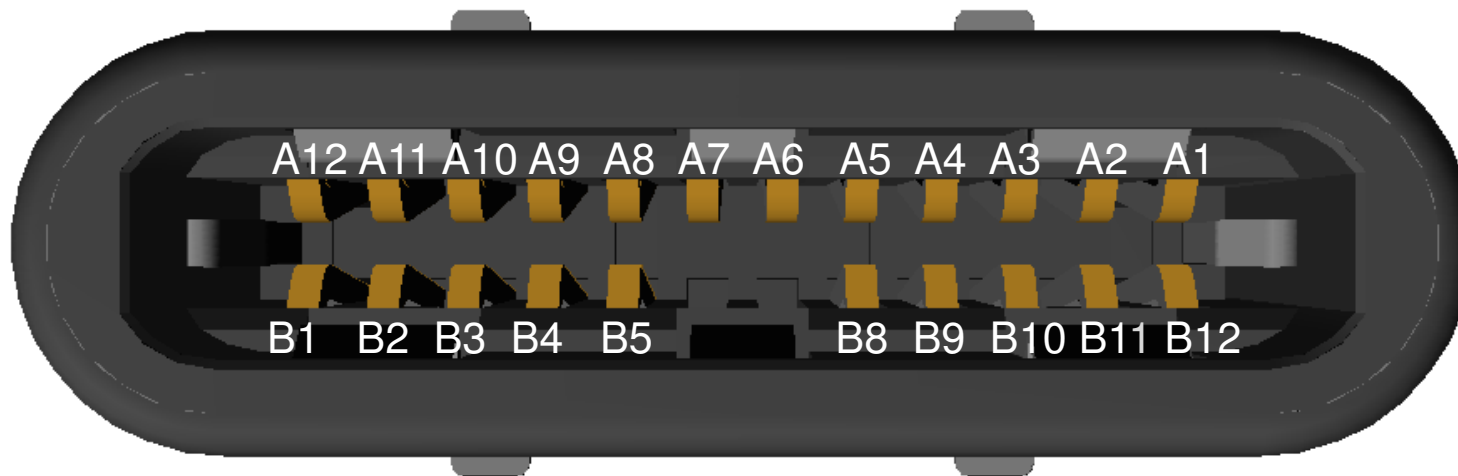
Type C Receptacles – 632 723 x00 011



- GND :** All pins (4) are connected together
- V_{BUS} :** All pins (4) are connected together
- D :** USB 2.0 Data pair
- TX :** 2 transmission pairs
- RX :** 2 reception pairs
- CC :** Configuration Channel : Detection & Power Management + HTD Management
- SBU :** Side Band use : Alternate modes (other standards)



Type C Plug – 632 712 000 011



- USB 2.0
- USB 3.0
- USB 3.1

A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1
GND	RX2+	RX2-	V _{BUS}	SBU1	D+	D-	CC1	V _{BUS}	TX1-	TX1+	GND
GND	TX2+	TX2-	V _{BUS}	CC2			SBU2	V _{BUS}	RX1-	RX1+	GND
B1	B2	B3	B4	B5			B8	B9	B10	B11	B12

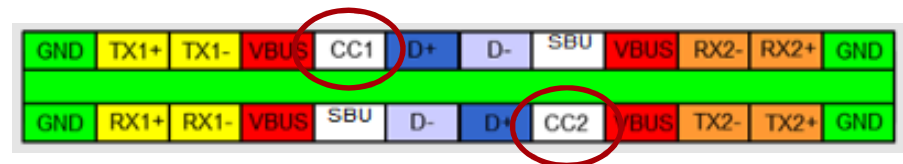
Configuration Channel

Providing the flexibility of Type-C

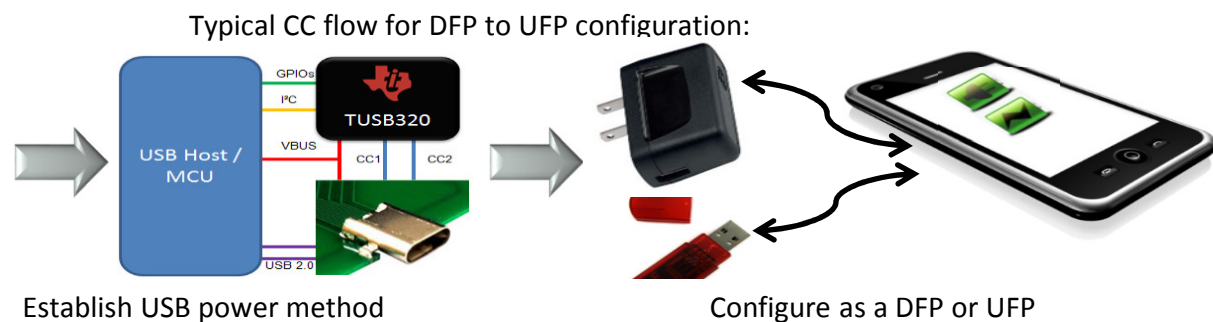


Functionally the Configuration Channel (CC) is used to serve the following purposes:

- Detect connect of USB ports,
- Resolve cable orientation and twist connections to establish USB data bus routing
- Establish DFP (sink) and UFP (source) roles between two connected ports
- Discover and configure power: USB Type-C current modes or USB Power Delivery
- Discovery and configuration of optional Alternate and Accessory modes



Detect valid connection



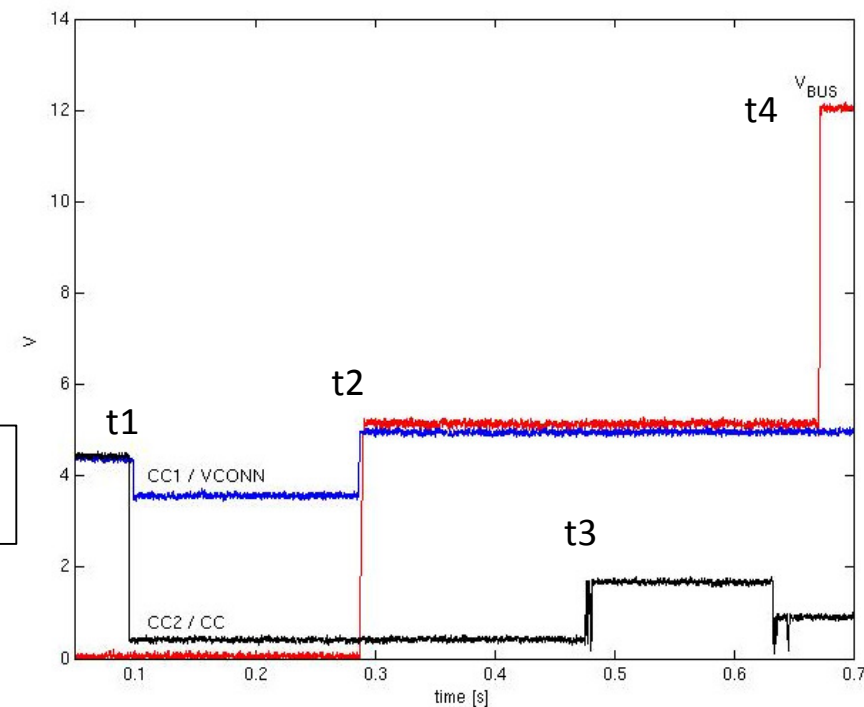
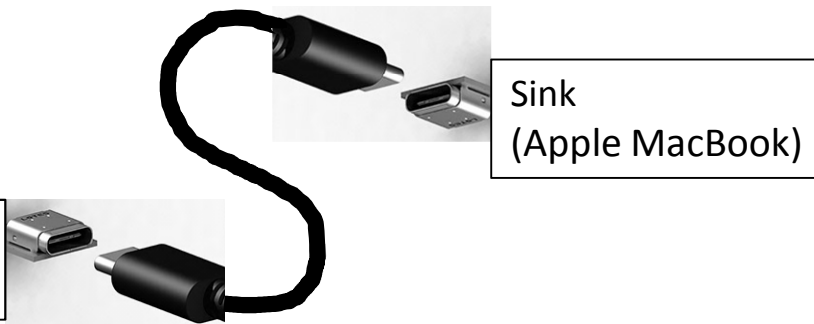
Establish USB power method

Configure as a DFP or UFP

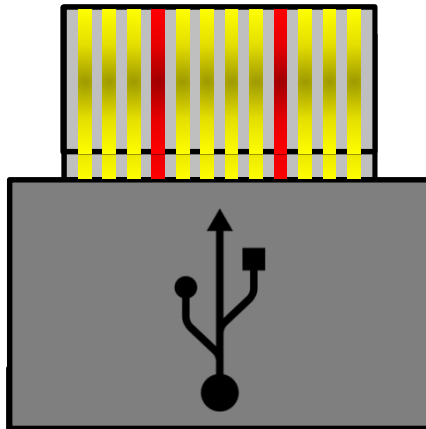
Typical Behavior upon Attachment

- The CC2 / CC line shows the voltages on the configuration channel between the sink and a source that applies VCONN to the cable.
- t1: the cable is attached.
- t2: the source confirms a valid sink is attached, then applies 5V to VBUS and VCONN.
- t3: USB Type-C 3A advertisement begins & USB PD messaging begins on CC line
- t4: VBUS voltage is increased to negotiated level.

AC/DC Adaptor
(TPS25741 EVM)



Potential Failure: Noncompliant Cables

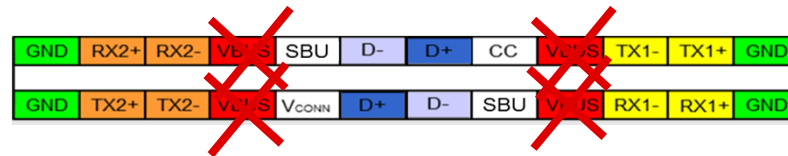


- Even if your system is not using USB PD (you are charging at 5V, 500mA), there are non-compliant cables that output 20V without PD negotiation
- If your system is not designed to handle 20V, then there would be a failure

• In a survey of USB Type-C cables available on Amazon, **28% of cables were not compliant to USB-IF specification.**
(Google Engineer Benson Leung: 20/71 cables out of specification)

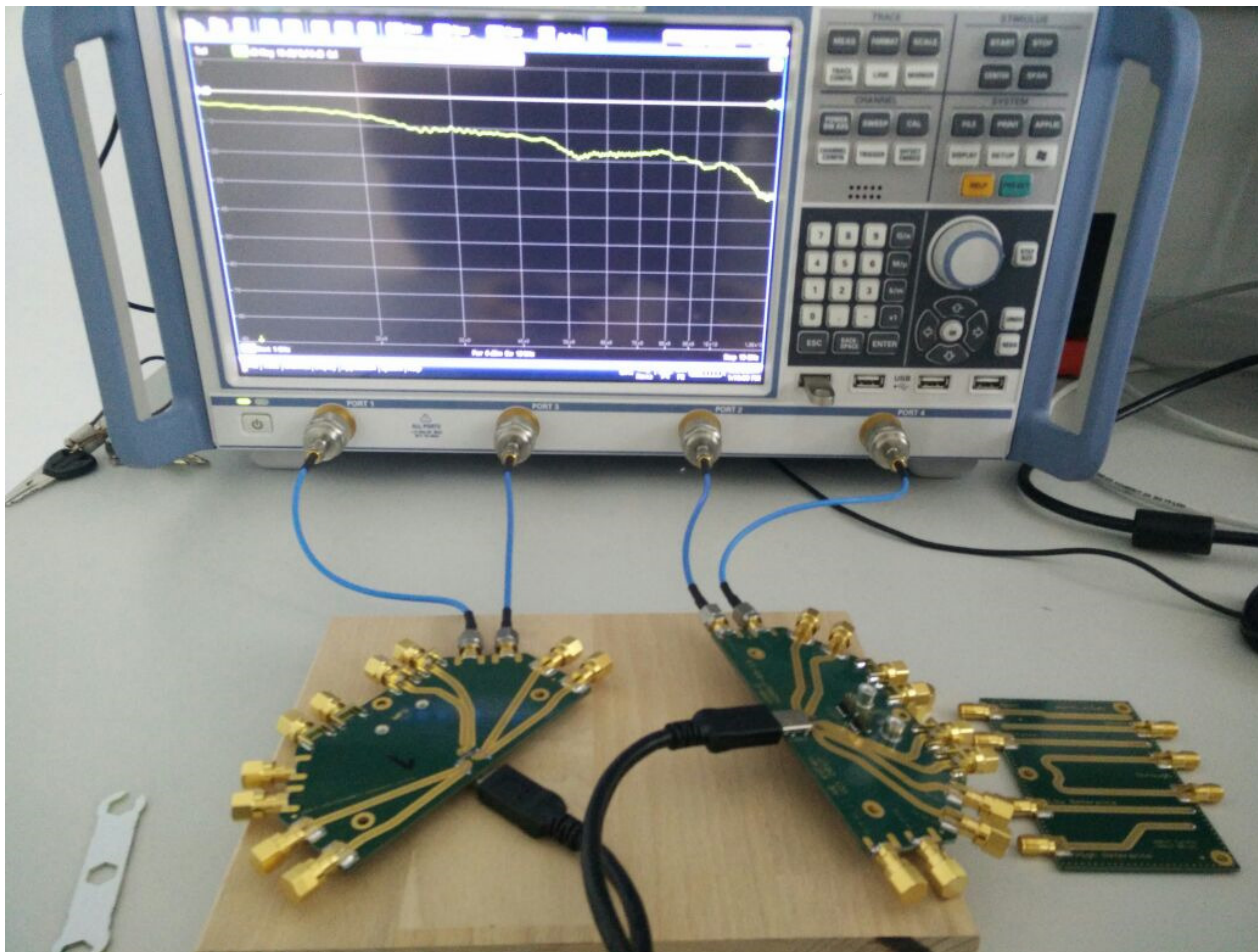
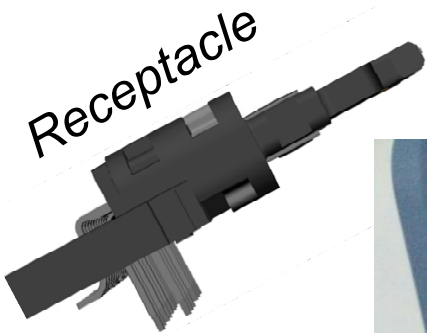
• Despite Amazon's ban there is still a risk of end user's purchasing non-compliant USB Type-C cables from cable manufacturers

Miswired USB
Type A-C Cable



Specification, Requirements & Performances

RF behavior



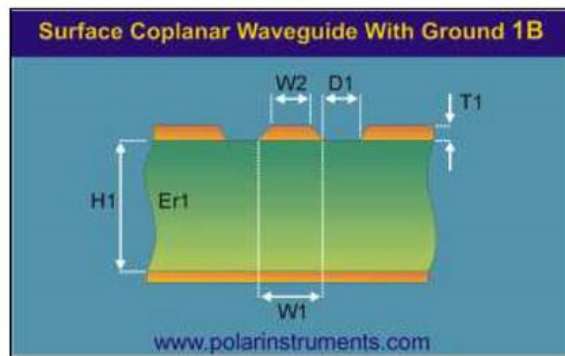
Specification, Requirements & Performances

RF behavior



Calibration board

Polar Si8000 Controlled Impedance Quick Solver



			<u>Toleranz</u>	<u>Minimum</u>	<u>Maximum</u>
Substrat 1 Dicke	H1	322,0000 +/-	0,0000	322,0000	322,0000
Substrat 1 Dielektrikum	Er1	4,6000 +/-	0,0000	4,6000	4,6000
Untere Leiterbreite	W1	450,0000 +/-	0,0000	450,0000	450,0000
Obere Leiterbreite	W2	420,0000 +/-	0,0000	420,0000	420,0000
Separation Massestreifen	D1	225,0000 +/-	0,0000	225,0000	225,0000
Leiterbahndicke	T1	50,0000 +/-	0,0000	50,0000	50,0000
<hr/>					
Impedanz	Zo	50,13	-----	0,00	0,00
Laufzeit (ps/m)	D	5725,350	-----	0,000	0,000
Induktivität (nH/m)	L	287,010	-----	0,000	0,000
Kapazität (pF/m)	C	114,211	-----	0,000	0,000

The microstrip conductor has to be like Würth Elektronik suggests.

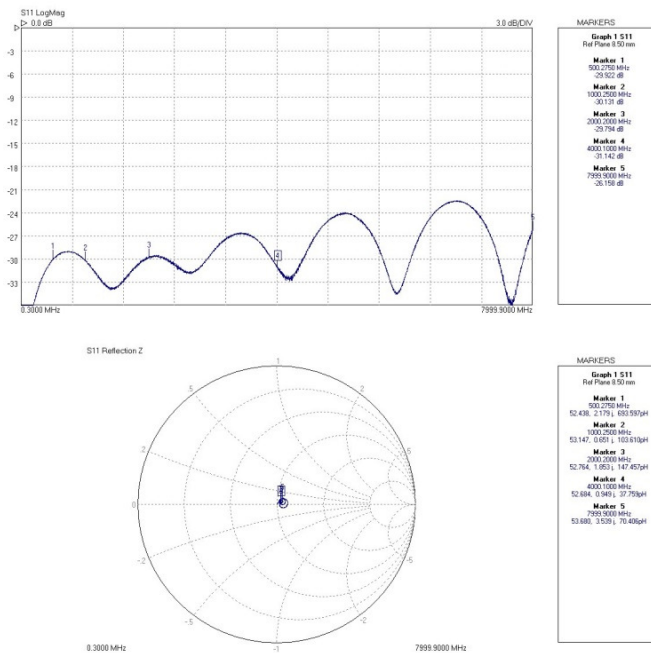
Specification, Requirements & Performances

RF behavior



Calibrationboard

The adjustment of the line:



This corresponds to a line impedance of approximately 53 Ω .

Specification, Requirements & Performances

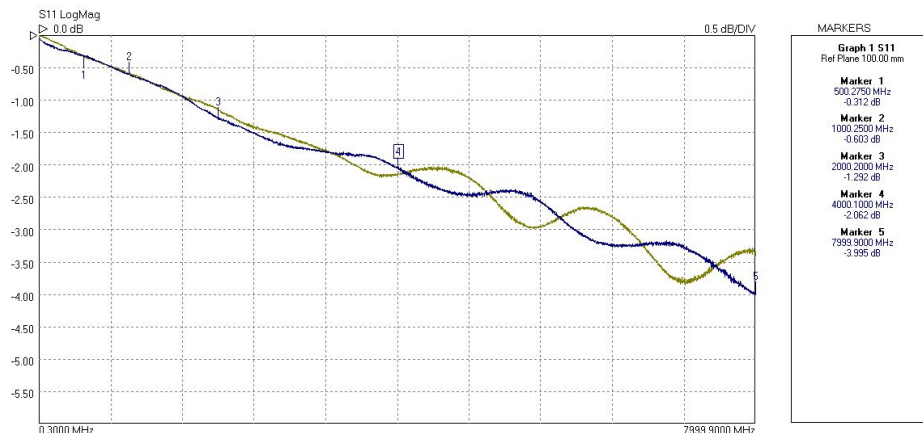
RF behavior



Calibrationboard

Insertion loss (reflection loss open / short)

As expected, open and short show a counter-image.



The real attenuation is half the value since the wave is attenuated on the return path.

1.5 dB / m at 0.5 GHz

3 dB / m at 1 GHz

6 dB / m at 2 GHz

10.5 dB / m at 4 GHz

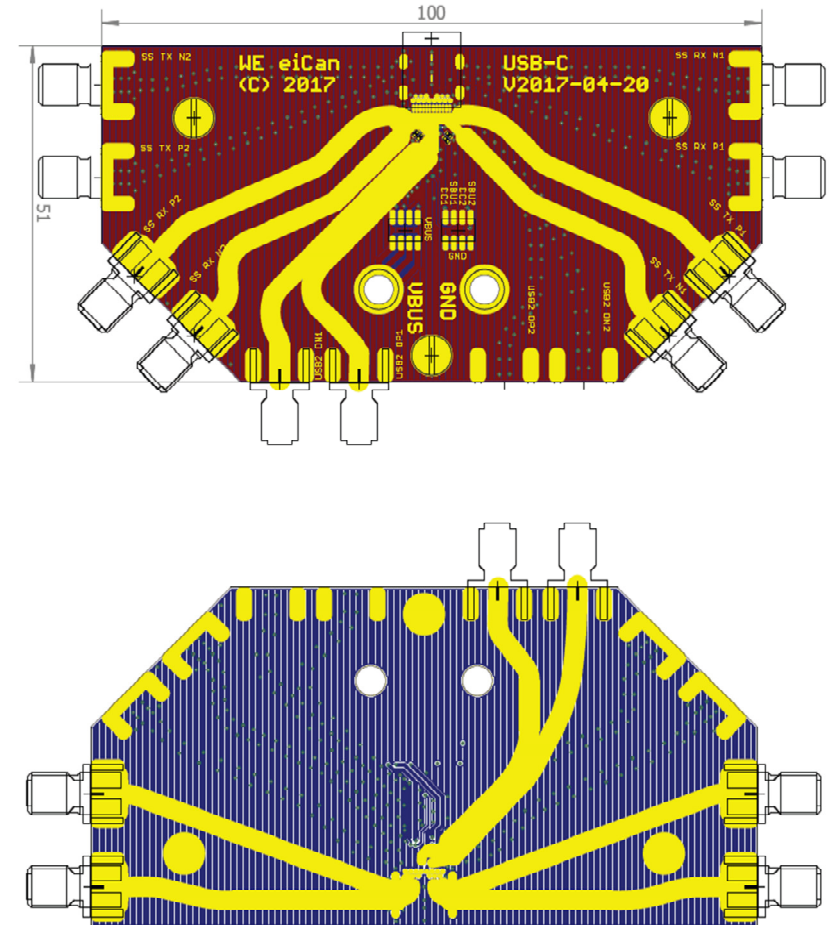
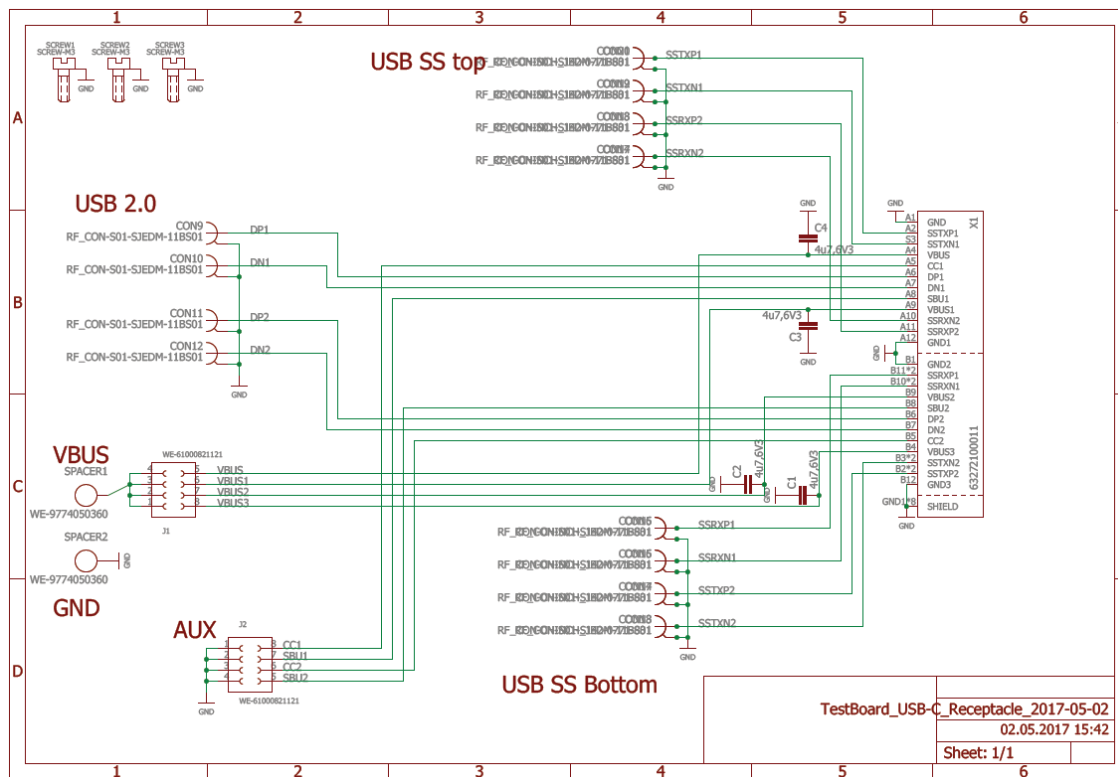
19 dB / m at 8 GHz

Specification, Requirements & Performances

RF behavior

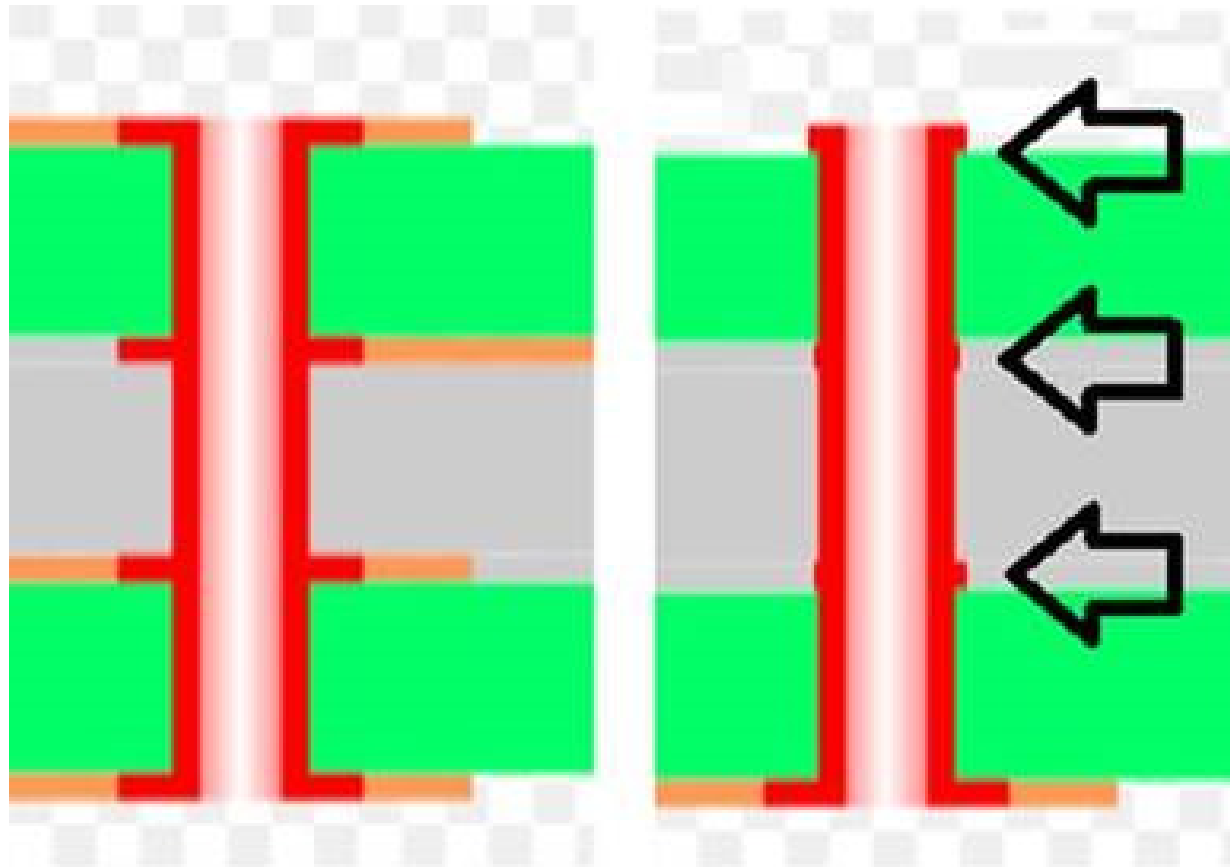


Testboard



Specification, Requirements & Performances

RF behavior



Testboard

VIA preparation:

Without rest ring is important to avoid capacitive and inductive effects between the layers.

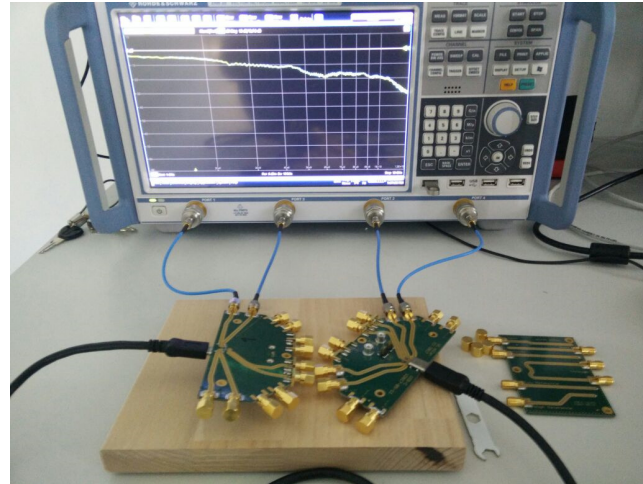
Specification, Requirements & Performances

RF behavior

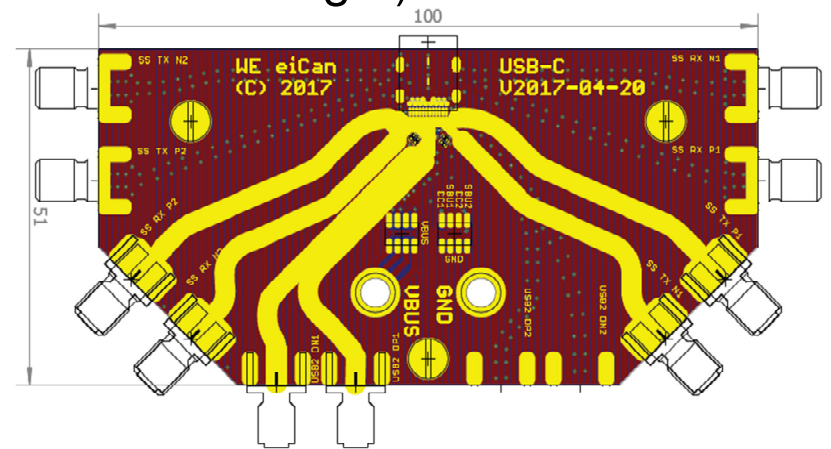
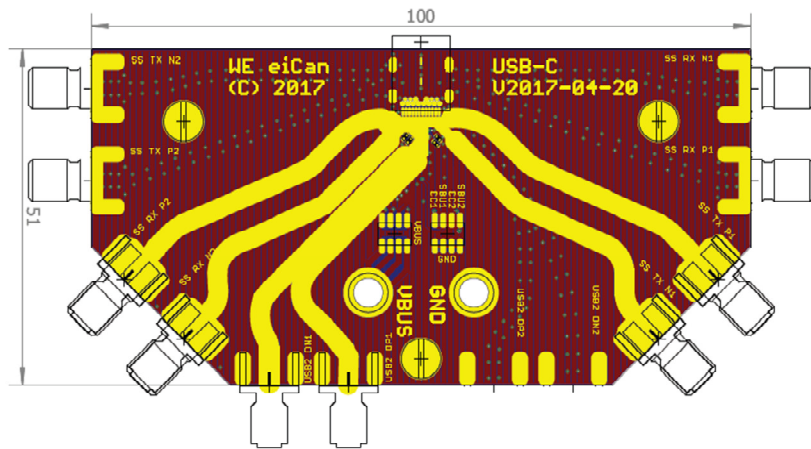
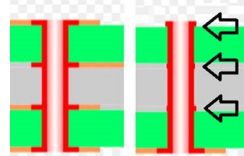
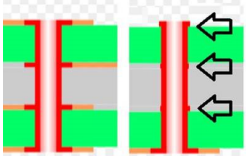


VIA
USB-C (Hybrid mount 623723300011)
USB-C Plug

VIA
USB-C (Hybrid mount 623723300011)
USB-C Plug



USB Cable (632910731731)
USB3.1 cable C Male to C Male 100cm length)

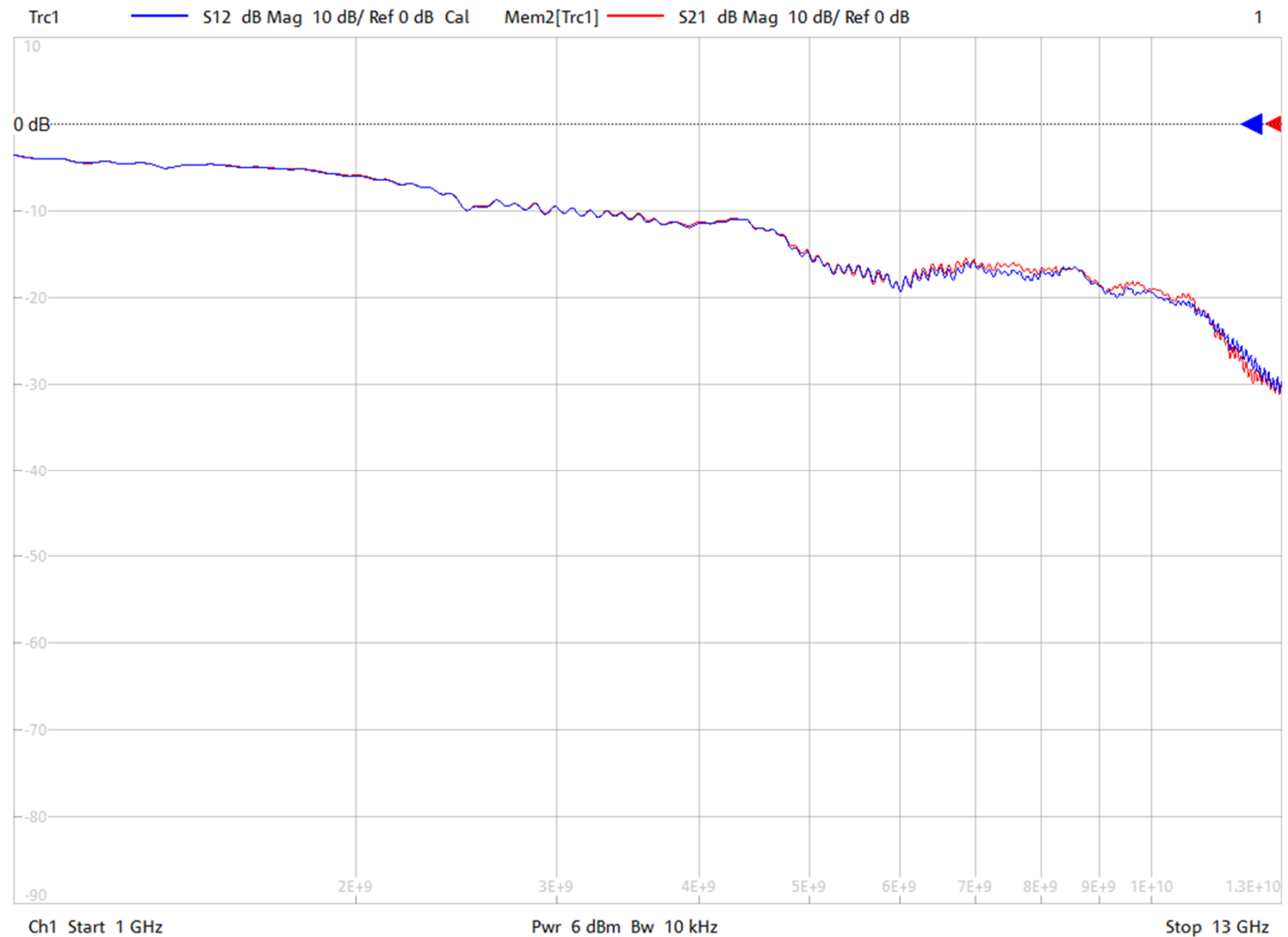


Specification, Requirements & Performances

RF behavior



Attenuation:

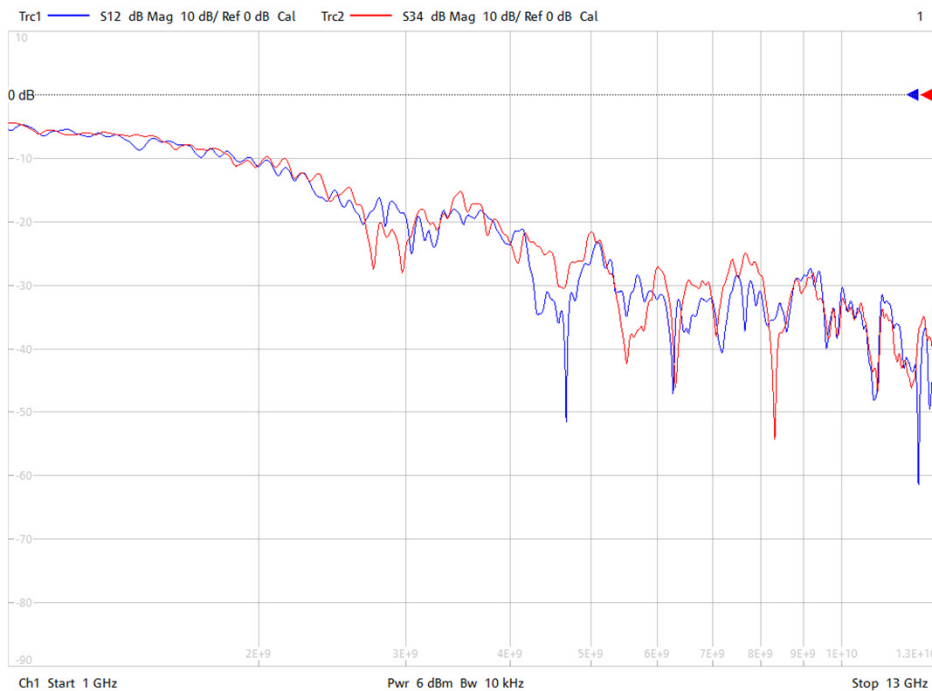


Specification, Requirements & Performances

RF behavior



Attenuation D1 – D1:
(S12 – S34)



Attenuation D2 – D2:
(S32 – S41)



Pairs of datalines are nearly simmilar!

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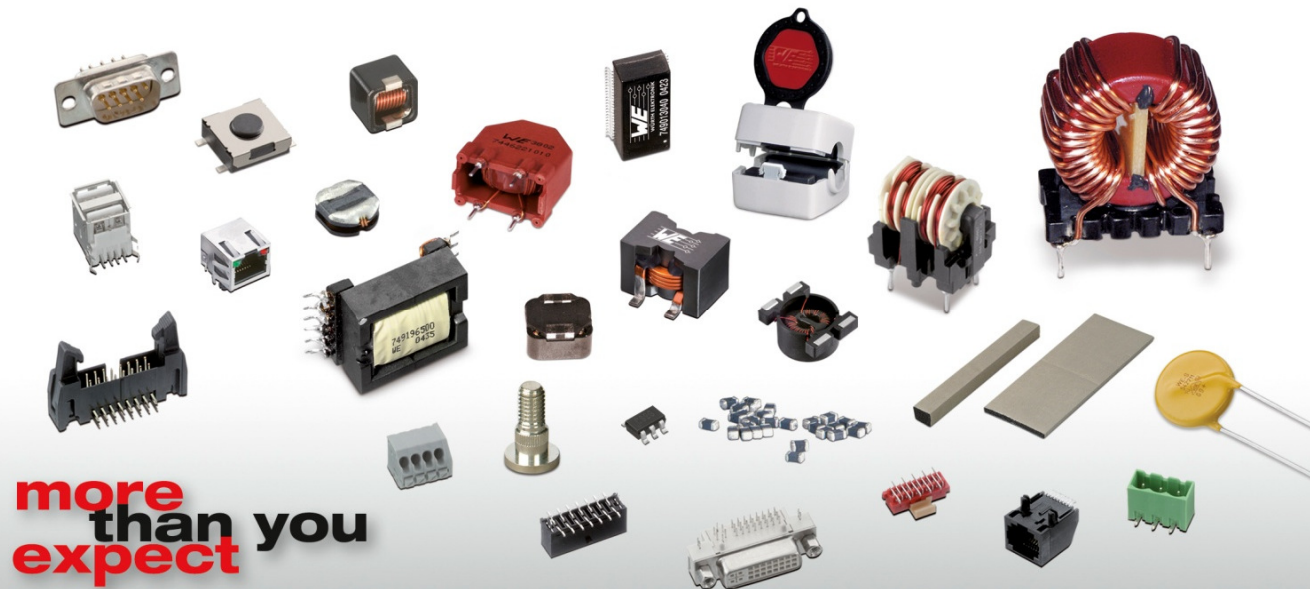
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